

Insulated Gate Bipolar Transistor (Ultrafast IGBT), 90 A



SOT-227

PRIMARY CHARACTERISTICS					
V _{CES}	1200 V				
V _{CE(on)} typical at 75 A, 25 °C	3.3 V				
I _C DC	90 A at 90 °C				
Speed	8 kHz to 30 kHz				
Package	SOT-227				
Circuit configuration	Single switch no diode				

FEATURES

- NPT Gen 5 IGBT technology
- Square RBSOA
- Positive V_{CE(on)} temperature coefficient
- Fully isolated package
- Speed 8 kHz to 60 kHz
- Very low internal inductance (≤ 5 nH typical)
- Industry standard outline
- UL approved file E78996



• Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

BENEFITS

- Designed for increased operating efficiency in power conversion: UPS, SMPS, welding, induction heating
- Easy to assemble and parallel
- · Direct mounting on heatsink
- Plug-in compatible with other SOT-227 packages
- · Low EMI, requires less snubbing

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS	
Collector to emitter voltage	V _{CES}		1200	V	
Continuous collector current		T _C = 25 °C	149		
Continuous collector current	I _C	T _C = 90 °C	90	A	
Pulsed collector current	I _{CM}		200	A	
Clamped inductive load current	I _{LM}		200		
Gate to emitter voltage	V_{GE}		± 20	V	
Power dissipation, IGBT	Ь	T _C = 25 °C	862	W	
	P _D	T _C = 90 °C	414	VV	
Isolation voltage	V _{ISOL}	Any terminal to case, t = 1 min	2500	V	



ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Collector to emitter breakdown voltage	V _{BR(CES)}	$V_{GE} = 0 \text{ V}, I_{C} = 250 \mu\text{A}$	1200	-	-		
	V _{CE(on)}	V _{GE} = 15 V, I _C = 75 A	-	3.3	3.8		
Collector to emitter voltage		V _{GE} = 15 V, I _C = 75 A, T _J = 125 °C	-	3.6	3.9	V	
		V _{GE} = 15 V, I _C = 75 A, T _J = 150 °C	-	3.7	-		
Gate threshold voltage	V _{GE(th)}	$V_{CE} = V_{GE}$, $I_C = 250 \mu A$	4	5	6		
		$V_{CE} = V_{GE}, I_{C} = 250 \mu A, T_{J} = 125 ^{\circ}C$	-	3.2	-		
Temperature coefficient of threshold voltage	$V_{GE(th)}/\Delta T_J$	$V_{CE} = V_{GE}$, $I_{C} = 1$ mA (25 °C to 125 °C)	-	-12	-	mV/°C	
Collector to emitter leakage current	I _{CES}	V _{GE} = 0 V, V _{CE} = 1200 V	-	7	250	μA	
		V _{GE} = 0 V, V _{CE} = 1200 V, T _J = 125 °C	-	1.4	10	mA	
		V _{GE} = 0 V, V _{CE} = 1200 V, T _J = 150 °C	-	6.5	20	IIIA	
Gate to emitter leakage current	I _{GES}	V _{GE} = ± 20 V	-	-	± 250	nA	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Total gate charge (turn-on)	Qg			-	690	-	
Gate to emitter charge (turn-on)	Q _{ge}	$I_C = 50 \text{ A}, V_{CC} = 600 \text{ V},$	V _{GE} = 15 V	-	65	-	nC
Gate to collector charge (turn-on)	Q _{gc}			-	250	-	
Turn-on switching loss	E _{on}			-	1.2	-	
Turn-off switching loss	E _{off}			-	2.1	-	mJ
Total switching loss	E _{tot}	$I_C = 75 \text{ A}, V_{CC} = 600 \text{ V},$		-	3.3	-	
Turn-on delay time	t _{d(on)}	$V_{GE} = 15 \text{ V}, R_{a} = 5 \Omega,$		-	250	-	
Rise time	t _r	$L = 500 \mu H, T_J = 25 °C$	Energy losses include tail and diode	-	38	-	ns
Turn-off delay time	t _{d(off)}			-	280	-	
Fall time	t _f			-	90	-	
Turn-on switching loss	E _{on}		recovery Diode used HFA16PB120	-	1.7	-	
Turn-off switching loss	E _{off}			-	4.08	-	mJ
Total switching loss	E _{tot}	$I_C = 75 \text{ A}, V_{CC} = 600 \text{ V},$		-	5.78	-	
Turn-on delay time	t _{d(on)}	$V_{GE} = 15 \text{ V}, R_{g} = 5 \Omega,$		-	245	-	
Rise time	t _r	L = 500 μH, T _J = 125 °C		-	48	-	
Turn-off delay time	t _{d(off)}			-	280	-	ns
Fall time	t _f			-	140	-	
Reverse bias safe operating area	RBSOA	T_J = 150 °C, I_C = 200 A, R_g = 22 Ω, V_{GE} = 15 V to 0 V, V_{CC} = 900 V, Fullsquare V_P = 1200 V, L = 500 μH					

THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL		MIN.	TYP.	MAX.	UNITS
Junction and storage temperature range	T _J , T _{Stg}		-40	-	150	°C
Thermal resistance junction to case	R _{thJC}		-	-	0.145	°C/W
Thermal resistance case to heatsink	R _{thCS}	Flat, greased surface	-	0.05	-	C/W
Weight			-	30	-	g
Mounting toyour		Torque to terminal	-	-	1.1 (9.7)	Nm (lbf.in)
Mounting torque		Torque to heatsink	-	-	1.8 (15.9)	Nm (lbf.in)
Case style			SOT-227			



www.vishay.com

Vishay Semiconductors

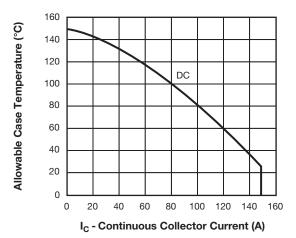


Fig. 1 - Maximum DC IGBT Collector Current vs. Case Temperature

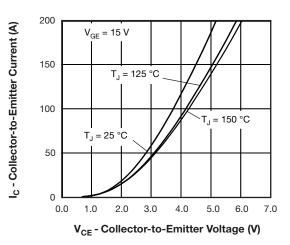


Fig. 2 - Typical Collector to Emitter Current Output Characteristics of IGBT

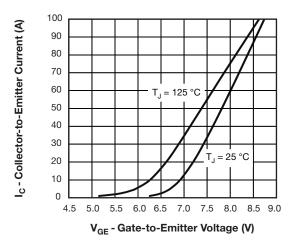


Fig. 3 - Typical IGBT Transfer Characteristics

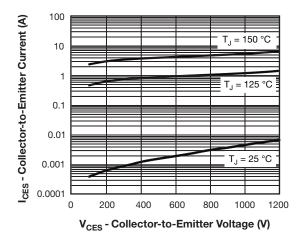


Fig. 4 - Typical IGBT Zero Gate Voltage Collector Current

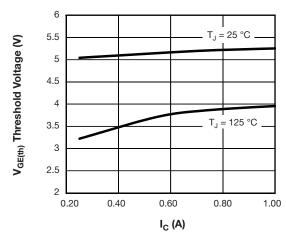


Fig. 5 - Typical IGBT Threshold Voltage

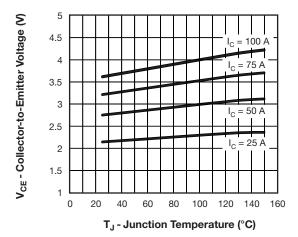
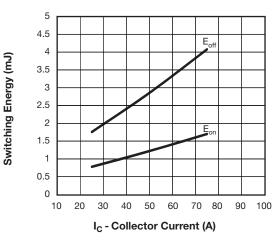


Fig. 6 - Typical IGBT Collector to Emitter Voltage vs. Junction Temperature, $V_{GE} = 15 \text{ V}$



www.vishay.com

Fig. 7 - Typical IGBT Energy Losses vs. I $_{C}$ T $_{J}$ = 125 °C, L = 500 μ H, V $_{CC}$ = 600 V, R $_{g}$ = 5 Ω , V $_{GE}$ = 15 V, Diode used HFA16PB120

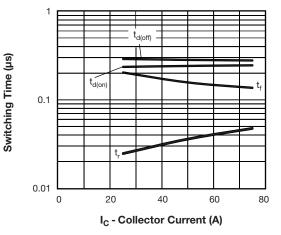


Fig. 8 - Typical IGBT Switching Time vs. I_C $T_J=125~^{\circ}C$, $L=500~\mu H,~V_{CC}=600~V,~R_q=5~\Omega,~V_{GE}=15~V,~Diode~used~HFA16PB12$

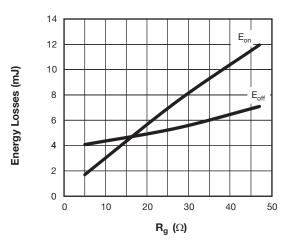


Fig. 9 - Typical IGBT Energy Loss vs. R $_g$, T $_J$ = 125 °C, I $_C$ = 75 A, L = 500 μ H, V $_{CC}$ = 600 V, V $_{GE}$ = 15 V, Diode used HFA16PB120

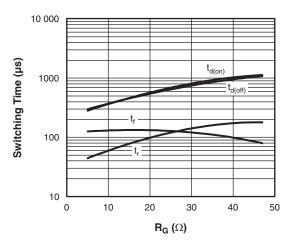


Fig. 10 - Typical IGBT Switching Time vs. R_g T_J = 125 °C, L = 500 μ H, V_{CC} = 600 V, R_g = 5 Ω , V_{GE} = 15 V

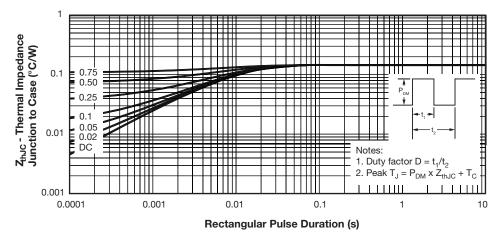


Fig. 11 - Maximum Thermal Impedance Zth,IC Characteristics (IGBT)

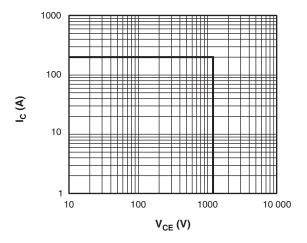
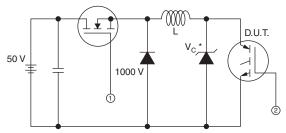


Fig. 12 - IGBT Reverse Bias SOA, TJ = 150 $^{\circ}$ C, V_{GE} = 15 V



- * Driver same type as D.U.T.; V $_{\rm C}$ = 80 % of V $_{\rm ce(max.)}$ * Note: Due to the 50 V power supply, pulse width and inductor will increase to obtain Id

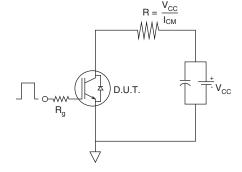


Fig. 13a - Clamped Inductive Load Test Circuit

Fig. 13b - Pulsed Collector Current Test Circuit

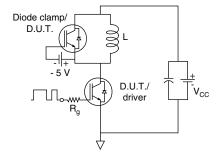


Fig. 14a - Switching Loss Test Circuit

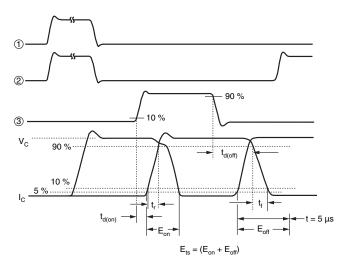


Fig. 14b - Switching Loss Waveforms Test Circuit

ORDERING INFORMATION TABLE

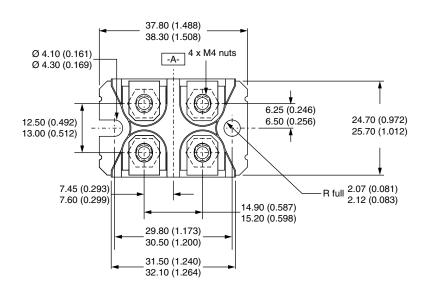
VS-**Device code** G В 90 S 120 U Α (1) (2) (3) (4) (5) (6)(7)(8) Vishay Semiconductors product 2 Insulated gate bipolar transistor (IGBT) B = IGBT Gen 5 Current rating (90 = 90 A) Circuit configuration (S = single switch no diode) 6 Package indicator (A = SOT-227) Voltage rating (120 = 1200 V) Speed/type (U = ultrafast IGBT)

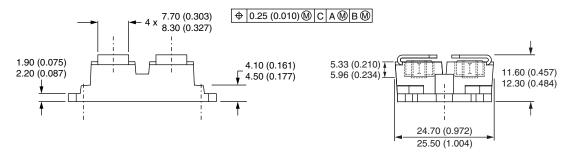
CIRCUIT CONFIGURATION					
CIRCUIT	CIRCUIT CONFIGURATION CODE	CIRCUIT DRAWING			
Single switch no diode	S	2 (G) 0 Lead Assignment 1 1 2 2			

LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95423			
Packaging information	www.vishay.com/doc?95425			

SOT-227 Generation 2

DIMENSIONS in millimeters (inches)





Note

· Controlling dimension: millimeter

Revision: 19-May-2020 1 Document Number: 95423

Legal Disclaimer Notice



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

© 2021 VISHAY INTERTECHNOLOGY, INC. ALL RIGHTS RESERVED